imall

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832 Email & Skype: info@chipsmall.com Web: www.chipsmall.com Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





Data Sheet

FEATURES

3 A maximum output current Low input voltage supply range $V_{IN} = 1.10$ V to 1.98 V, no external bias supply required Fixed output voltage range: Vout FIXED = 0.9 V to 1.5 V Adjustable output voltage range: Vout ADJ = 0.5 V to 1.5 V Ultralow noise: 2 µV rms, 100 Hz to 100 kHz Noise spectral density 4 nV/√Hz at 10 kHz 3 nV/√Hz at 100 kHz Low dropout voltage: 95 mV typical at 3 A load Operating supply current: 4.5 mA typical at no load ±1.5% fixed output voltage accuracy over line, load, and temperature Excellent power supply rejection ratio (PSRR) performance 59 dB typical at 10 kHz at 3 A load 43 dB typical at 100 kHz at 3 A load Excellent load/line transient response Soft start to reduce inrush current Optimized for small 10 µF ceramic capacitors

Current-limit and thermal overload protection

Power-good indicator

Precision enable

16-lead, 3 mm × 3 mm LFCSP package

APPLICATIONS

Regulation to noise sensitive applications such as radio frequency (RF) transceivers, analog-to-digital converter (ADC) and digital-to-analog converter (DAC) circuits, phase-locked loops (PLLs), voltage controlled oscillators (VCOs) and clocking integrated circuits

Field-programmable gate array (FPGA) and digital signal processor (DSP) supplies

Medical and healthcare Industrial and instrumentation

GENERAL DESCRIPTION

The ADP1763 is a low noise, low dropout (LDO) linear regulator. It is designed to operate from a single input supply with an input voltage as low as 1.10 V without the requirement of an external bias supply to increase efficiency and provide up to 3 A of output current.

The low 95 mV typical dropout voltage at a 3 A load allows the ADP1763 to operate with a small headroom while maintaining regulation and providing better efficiency.

The ADP1763 is optimized for stable operation with small 10 μ F ceramic output capacitors. The ADP1763 delivers optimal transient performance with minimal board area.

Rev. A Document Feedback Information furnished by Analog Devices is believed to be accurate and reliable. However, no responsibility is assumed by Analog Devices for its use, nor for any infringements of patents or other rights of third parties that may result from its use. Specifications subject to change without notice. No license is granted by implication or otherwise under any patent or patent rights of Analog Devices. Trademarks and registered trademarks are the property of their respective owners.

3 A, Low V_{IN} , Low Noise, CMOS Linear Regulator

ADP1763

10kΩ

CREF

TYPICAL APPLICATION CIRCUITS

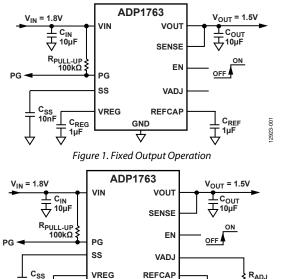


Figure 2. Adjustable Output Operation

GND

Table 1. Related Devices

10nF

1μ

C_{REG}

Device	Input Voltage	Maximum Current	Fixed/ Adjustable	Package	
ADP1761	1.10 V to 1.98 V	1 A	Fixed/adjustable	16-lead LFCSP	
ADP1762	1.10 V to 1.98 V	2 A	Fixed/adjustable	16-lead LFCSP	
ADP1740/ ADP1741	1.6 V to 3.6 V	2 A	Fixed/adjustable	16-lead LFCSP	
ADP1752/ ADP1753	1.6 V to 3.6 V	0.8 A	Fixed/adjustable	16-lead LFCSP	
ADP1754/ ADP1755	1.6 V to 3.6 V	1.2 A	Fixed/adjustable	16-lead LFCSP	

The ADP1763 is available in fixed output voltages ranging from 0.9 V to 1.5 V. The output of the adjustable output model can be set from 0.5 V to 1.5 V through an external resistor connected between VADJ and ground.

The ADP1763 has an externally programmable soft start time by connecting a capacitor to the SS pin. Short-circuit and thermal overload protection circuits prevent damage in adverse conditions. The ADP1763 is available in a small 16-lead LFCSP package for the smallest footprint solution to meet a variety of applications.

One Technology Way, P.O. Box 9106, Norwood, MA 02062-9106, U.S.A. Tel: 781.329.4700 ©2016 Analog Devices, Inc. All rights reserved. Technical Support www.analog.com

ADP1763* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS

View a parametric search of comparable parts.

EVALUATION KITS

ADP1761/ADP1762/ADP1763 Evaluation Board

DOCUMENTATION

Application Notes

• AN-1421: Paralleling the ADP1763 LDO Regulators for High Output Current Applications

Data Sheet

 ADP1763: 3 A, Low V_{IN}, Low Noise, CMOS Linear Regulator Data Sheet

User Guides

• UG-954: Evaluating the ADP1761/ADP1762/ADP1763 Low VIN, Low Noise, CMOS Linear Regulators

TOOLS AND SIMULATIONS \square

- ADI Linear Regulator Design Tool and Parametric Search
- ADIsimPower[™] Voltage Regulator Design Tool

REFERENCE MATERIALS

Press

• Analog Devices' Low Dropout Regulators Enable Cleaner and Faster Communications

DESIGN RESOURCES 🖵

- ADP1763 Material Declaration
- PCN-PDN Information
- Quality And Reliability
- Symbols and Footprints

DISCUSSIONS

View all ADP1763 EngineerZone Discussions.

SAMPLE AND BUY

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖵

Submit a technical question or find your regional support number.

DOCUMENT FEEDBACK

Submit feedback for this data sheet.

TABLE OF CONTENTS

Features 1
Applications1
General Description1
Typical Application Circuits1
Revision History
Specifications
Input and Output Capacitor: Recommended Specifications . 4
Absolute Maximum Ratings5
Thermal Data 5
Thermal Resistance
ESD Caution
Pin Configuration and Function Descriptions
Typical Performance Characteristics7
Theory of Operation

Soft Start Function11Adjustable Output Voltage12Enable Feature12Power-Good (PG) Feature12Applications Information13Capacitor Selection13Undervoltage Lockout14Current-Limit and Thermal Overload Protection14Paralleling ADP1763 for High Current Applications15PCB Layout Considerations17Outline Dimensions18Ordering Guide18

REVISION HISTORY

9/2016—Rev. 0 to Rev. A	
Changes to Figure 23 and Figure 2	2411

4/2016—Revision 0: Initial Version

SPECIFICATIONS

 $V_{IN} = V_{OUT} + 0.2 \text{ V or } V_{IN} = 1.1 \text{ V}, \text{ whichever is greater, } I_{LOAD} = 10 \text{ mA}, C_{IN} = 10 \text{ } \mu\text{F}, C_{OUT} = 10 \text{ } \mu\text{F}, C_{REF} = 1 \text{ } \mu\text{F}, C_{REG} = 1 \text{ } \mu\text{F}, T_A = 25^{\circ}\text{C}, \text{ Minimum and maximum limits at } T_J = -40^{\circ}\text{C} \text{ to } +125^{\circ}\text{C}, \text{ unless otherwise noted.}$

Table 2. Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
INPUT VOLTAGE SUPPLY RANGE	V _{IN}	T」 = −40°C to +125°C	1.10		1.98	V
CURRENT						
Operating Supply Current	I _{GND}	$I_{LOAD} = 0 \ \mu A$		4.5	8	mA
		$I_{LOAD} = 10 \text{ mA}$		4.9	8	mA
		$I_{LOAD} = 100 \text{ mA}$		5.5	8.5	mA
		$I_{LOAD} = 3 A$		12	16	mA
Shutdown Current	I _{GND-SD}	EN = GND		2		μA
		$T_{J} = -40^{\circ}C \text{ to } +85^{\circ}C,$			180	μA
		$V_{IN} = (V_{OUT} + 0.2 \text{ V}) \text{ to } 1.98 \text{ V}$				
		T _J = 85°C to 125°C,			800	μΑ
		$V_{IN} = (V_{OUT} + 0.2 \text{ V}) \text{ to } 1.98 \text{ V}$				
OUTPUT NOISE ¹		10 Hz to 100 kHz, $V_{IN} = 1.1$ V, $V_{OUT} = 0.9$ V		12		μV rms
		100 Hz to 100 kHz, $V_{IN} = 1.1 \text{ V}$, $V_{OUT} = 0.9 \text{ V}$		2		μV rms
		10 Hz to 100 kHz, V_{IN} = 1.5 V, V_{OUT} = 1.3 V		15		μV rms
		100 Hz to 100 kHz, $V_{IN} = 1.5$ V, $V_{OUT} = 1.3$ V		2		μV rms
		10 Hz to 100 kHz, $V_{IN} = 1.7$ V, $V_{OUT} = 1.5$ V		21		μV rms
		100 Hz to 100 kHz, $V_{IN} = 1.7 V$, $V_{OUT} = 1.5 V$		2		μV rms
Noise Spectral Density		$V_{OUT} = 0.9 \text{ V}$ to 1.5 V, $I_{LOAD} = 100 \text{ mA}$				
		At 10 kHz		4		nV/√Hz
		At 100 kHz		3		nV/√Hz
POWER SUPPLY REJECTION RATIO ¹	PSRR	$I_{LOAD} = 3 \text{ A, modulated } V_{IN}$				
		$10 \text{ kHz}, V_{OUT} = 1.3 \text{ V}, V_{IN} = 1.7 \text{ V}$		59		dB
		$100 \text{ kHz}, V_{OUT} = 1.3 \text{ V}, V_{IN} = 1.7 \text{ V}$		43		dB
		$1 \text{ MHz}, V_{OUT} = 1.3 \text{ V}, V_{IN} = 1.7 \text{ V}$		37		dB
		$10 \text{ kHz}, V_{\text{OUT}} = 0.9 \text{ V}, V_{\text{IN}} = 1.3 \text{ V}$		62		dB
		$100 \text{ kHz}, V_{OUT} = 0.9 \text{ V}, V_{IN} = 1.3 \text{ V}$		45		dB
		$1 \text{ MHz}, V_{\text{OUT}} = 0.9 \text{ V}, V_{\text{IN}} = 1.3 \text{ V}$		33		dB
OUTPUT VOLTAGE						
Output Voltage Range		$T_A = 25^{\circ}C$				
	Vout_fixed		0.9		1.5	V
	Vout_adj		0.5		1.5	V
Fixed Output Voltage Accuracy	Vout	$I_{LOAD} = 100 \text{ mA}, T_A = 25^{\circ}\text{C}$	-0.5		+0.5	%
		10 mA < I_{LOAD} < 3 A, $V_{IN} = (V_{OUT} + 0.2 V)$ to 1.98 V, $T_J = 0^{\circ}C$ to 85°C	-1		+1.5	%
		10 mA < I_{LOAD} < 3 A, V_{IN} = (V_{OUT} + 0.2 V) to 1.98 V	-1.5		+1.5	%
ADJUSTABLE PIN CURRENT	I _{ADJ}	$T_A = 25^{\circ}C$	49.5	50.0	50.5	μΑ
		$V_{IN} = (V_{OUT} + 0.2 \text{ V}) \text{ to } 1.98 \text{ V}$	48.8	50.0	51.0	μΑ
ADJUSTABLE OUTPUT VOLTAGE GAIN FACTOR	AD	$T_A = 25^{\circ}C$		3.0		
		$V_{IN} = (V_{OUT} + 0.2 \text{ V}) \text{ to } 1.98 \text{ V}$	2.95		3.055	
REGULATION						
Line Regulation	$\Delta V_{OUT}/\Delta V_{IN}$	$V_{IN} = (V_{OUT} + 0.2 \text{ V}) \text{ to } 1.98 \text{ V}$	-0.15		+0.15	%/V
Load Regulation ²	ΔVουτ/ΔΙουτ	$I_{LOAD} = 10 \text{ mA to } 3 \text{ A}$		0.12	0.45	%/A
DROPOUT VOLTAGE ³	VDROPOUT	$I_{LOAD} = 100 \text{ mA}, V_{OUT} \ge 1.2 \text{ V}$		12	23	mV
		$I_{LOAD} = 3 \text{ A}, V_{OUT} \ge 1.2 \text{ V}$		95	145	mV
START-UP TIME ^{1, 4}	t _{start-up}	$C_{SS} = 10 \text{ nF}, V_{OUT} = 1.3 \text{ V}$		0.6		ms
SOFT START CURRENT	lss	$1.1 \text{ V} \le \text{V}_{\text{IN}} \le 1.98 \text{ V}$	8	10	12	μA
CURRENT-LIMIT THRESHOLD ⁵	ILIMIT		3.3	4	5	A

Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
THERMAL SHUTDOWN						
Threshold	TS _{SD}	T _J rising		150		°C
Hysteresis	TS _{SD-HYS}			15		°C
POWER-GOOD (PG) OUTPUT THRESHOLD						
Output Voltage						
Falling	PG _{FALL}	$1.1~V \leq V_{\rm IN} \leq 1.98~V$		-7.5		%
Rising	PGRISE	$1.1~V \leq V_{\rm IN} \leq 1.98~V$		-5		%
PG OUTPUT						
Output Voltage Low	PGLOW	$1.1~V \leq V_{\text{IN}} \leq 1.98~V,~I_{\text{PG}} \leq 1~mA$			0.35	V
Leakage Current	IPG-LKG	$1.1~V \leq V_{\rm IN} \leq 1.98~V$		0.01	1	μΑ
Delay ¹	PG _{DELAY}	ENRISING tO PGRISING		0.75		ms
PRECISION EN INPUT		$1.1 \text{ V} \le V_{\text{IN}} \le 1.98 \text{ V}$				
Logic Input						
High	ENHIGH		595	625	690	mV
Low	EN _{LOW}		550	580	630	mV
Input Logic Hysteresis	EN _{HYS}			45		mV
Input Leakage Current	I _{EN-LKG}	$EN = V_{IN} \text{ or } GND$		0.01	1	μΑ
Input Delay Time	tlen-dly	From EN rising from 0 V to V_{IN} to 0.1 \times V_{OUT}		100		μs
UNDERVOLTAGE LOCKOUT	UVLO					
Input Voltage						
Rising	UVLORISE	$T_{J} = -40^{\circ}C \text{ to } +125^{\circ}C$		1.01	1.06	V
Falling	UVLOFALL	$T_{J} = -40^{\circ}C \text{ to } +125^{\circ}C$	0.87	0.93		V
Hysteresis	UVLO _{HYS}			80		mV

¹ Guaranteed by design and characterization; not production tested.

² Based on an endpoint calculation using 10 mA and 3 A loads.

³ Dropout voltage is defined as the input to output voltage differential when the input voltage is set to the nominal output voltage, which applies only for output voltages above 1.1 V.

⁴ Start-up time is defined as the time from the rising edge of EN to VOUT being at 90% of its nominal value.

⁵ Current-limit threshold is defined as the current at which the output voltage drops to 90% of the specified typical value. For example, the current limit for a 1.0 V output voltage is defined as the current that causes the output voltage to drop to 90% of 1.0 V, or 0.9 V.

INPUT AND OUTPUT CAPACITOR: RECOMMENDED SPECIFICATIONS

Parameter	Symbol	Test Conditions/Comments	Min	Тур	Max	Unit
CAPACITANCE ¹		$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$				
Input	CIN		7.0	10		μF
Output	Cout		7.0	10		μF
Regulator	C _{REG}		0.7	1		μF
Reference	CREF		0.7	1		μF
CAPACITOR EQUIVALENT SERIES RESISTANCE (ESR)	R _{ESR}	$T_A = -40^{\circ}C \text{ to } +125^{\circ}C$				
CIN, COUT			0.001		0.5	Ω
CREG, CREF			0.001		0.2	Ω

¹ The minimum input and output capacitance must be >7.0 μ F over the full range of the operating conditions. Consider the full range of the operating conditions in the application during device selection to ensure that the minimum capacitance specification is met. X7R and X5R type capacitors are recommended. Y5V and Z5U capacitors are not recommended for use with any LDO.

ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
VIN to GND	–0.3 V to +2.16 V
EN to GND	–0.3 V to +3.96 V
VOUT to GND	–0.3 V to VIN
SENSE to GND	–0.3 V to VIN
VREG to GND	–0.3 V to VIN
REFCAP to GND	–0.3 V to VIN
VADJ to GND	–0.3 V to VIN
SS to GND	–0.3 V to VIN
PG to GND	–0.3 V to +3.96 V
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	-40°C to +125°C
Operating Junction Temperature	125°C
Lead Temperature (Soldering, 10 sec)	300°C

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

THERMAL DATA

Absolute maximum ratings apply only individually, not in combination. The ADP1763 may be damaged when junction temperature limits are exceeded. Monitoring ambient temperature does not guarantee that the junction temperature is within the specified temperature limits. In applications with high power dissipation and poor thermal resistance, the maximum ambient temperature may need to be derated.

In applications with moderate power dissipation and low printed circuit board (PCB) thermal resistance, the maximum ambient temperature can exceed the maximum limit as long as the junction temperature is within specification limits. The junction temperature (T_J) of the device is dependent on the ambient temperature (T_A), the power dissipation of the device (P_D), and the junction to ambient thermal resistance of the package (θ_{JA}). T_J is calculated using the following formula:

$$T_J = T_A + (P_D \times \theta_{JA})$$

The junction to ambient thermal resistance (θ_{JA}) of the package is based on modeling and a calculation using a 4-layer board. The junction to ambient thermal resistance is highly dependent on the application and board layout. In applications where high maximum power dissipation exists, close attention to thermal board design is required. The value of θ_{JA} may vary, depending on PCB material, layout, and environmental conditions. The specified values of θ_{JA} are based on a 4-layer, 4 in × 3 in circuit board. For details about board construction, refer to JEDEC JESD51-7.

 Ψ_{JB} is the junction to board thermal characterization parameter with units of °C/W. Ψ_{JB} of the package is based on modeling and a calculation using a 4-layer board. The JEDEC JESD51-12 document, *Guidelines for Reporting and Using Package Thermal Information*, states that thermal characterization parameters are not the same as thermal resistances. Ψ_{JB} measures the component power flowing through multiple thermal paths rather than a single path, as in thermal resistance (θ_{JB}). Therefore, Ψ_{JB} thermal paths include convection from the top of the package as well as radiation from the package, factors that make Ψ_{JB} more useful in realworld applications. The maximum junction temperature (T_J) is calculated from the board temperature (T_B) and power dissipation (P_D), using the following formula:

 $T_J = T_B + (P_D \times \Psi_{JB})$

Refer to the JEDEC JESD51-8 and JESD51-12 documents for more detailed information about Ψ_{JB} .

THERMAL RESISTANCE

 θ_{JA} and Ψ_{JB} are specified for the worst case conditions, that is, a device soldered in a circuit board for surface-mount packages.

Package Type	θ」Α	Ψ_{JB}	Unit
16-Lead LFCSP	56	28.4	°C/W

ESD CAUTION



ESD (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

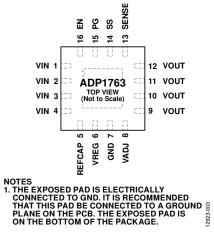


Figure 3. Pin Configuration

Table 6. Pin Function Descriptions

Pin No.	Mnemonic	Description
1 to 4	VIN	Regulator Input Supply. Bypass VIN to GND with a 10 µF or greater capacitor. Note that all four VIN pins must be connected to the source supply.
5	REFCAP	Reference Filter Capacitor. Connect a 1 μ F capacitor from the REFCAP pin to ground. Do not connect a load to ground.
6	VREG	Regulated Input Supply to LDO Amplifier. Bypass VREG to GND with a 1 μ F or greater capacitor. Do not connect a load to ground.
7	GND	Ground.
8	VADJ	Adjustable Voltage Pin for the Adjustable Output Option. Connect a 10 k Ω external resistor between the VADJ pin and ground to set the output voltage to 1.5 V. For the fixed output option, leave this pin floating.
9 to 12	VOUT	Regulated Output Voltage. Bypass VOUT to GND with a 10 μ F or greater capacitor. Note that all four VOUT pins must be connected to the load.
13	SENSE	Sense Input. The SENSE pin measures the actual output voltage at the load and feeds it to the error amplifier. Connect VSENSE as close to the load as possible to minimize the effect of IR voltage drop between VOUT and the load.
14	SS	Soft Start Pin. A 10 nF capacitor connected to the SS pin and ground sets the start-up time to 0.6 ms.
15	PG	Power-Good Output. This open-drain output requires an external pull-up resistor. If the device is in shutdown mode, current-limit mode, or thermal shutdown mode, or if VOUT falls below 90% of the nominal output voltage, the PG pin immediately transitions low.
16	EN	Enable Input. Drive the EN pin high to turn on the regulator. Drive the EN pin low to turn off the regulator. For automatic startup, connect the EN pin to the VIN pin.
	EP	Exposed Pad. The exposed pad is electrically connected to GND. It is recommended that this pad be connected to a ground plane on the PCB. The exposed pad is on the bottom of the package.

TYPICAL PERFORMANCE CHARACTERISTICS

 V_{IN} = 1.5 V, V_{OUT} = 1.3 V, T_A = 25°C, unless otherwise noted.

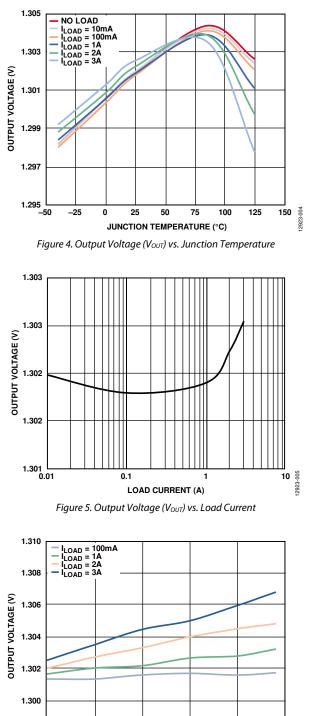


Figure 6. Output Voltage vs. Input Voltage

INPUT VOLTAGE (V)

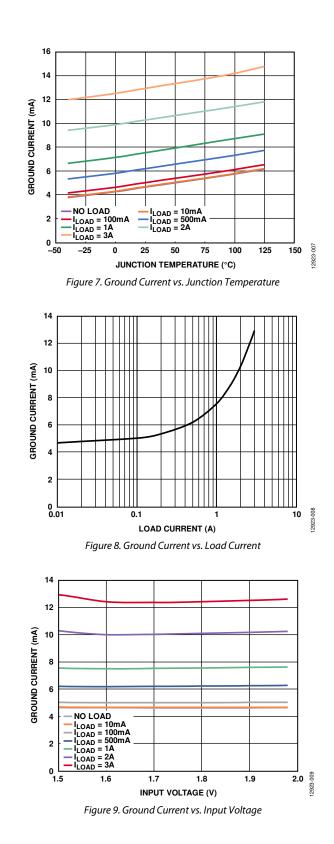
1.7

1.8

1.9

1.298 └─ 1.5

1.6



12923-006

2.0

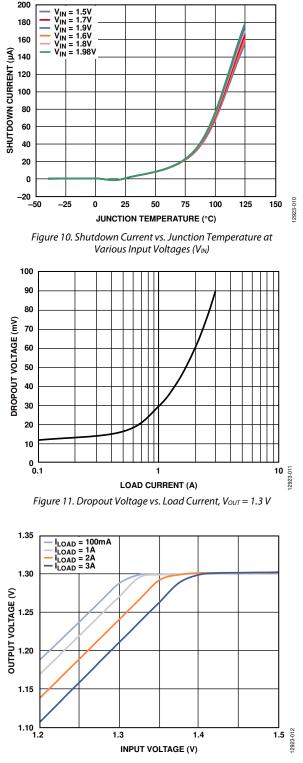


Figure 12. Output Voltage vs. Input Voltage (in Dropout), $V_{OUT} = 1.3 V$

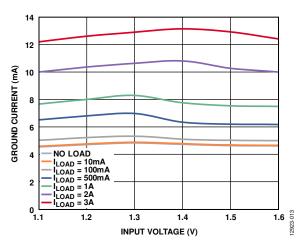


Figure 13. Ground Current vs. Input Voltage (in Dropout), Vout = 1.3 V

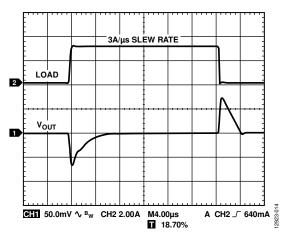


Figure 14. Load Transient Response, $C_{OUT} = 10 \ \mu\text{F}$, $V_{IN} = 1.8 \ V$, $V_{OUT} = 1.3 \ V$

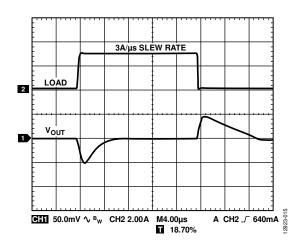
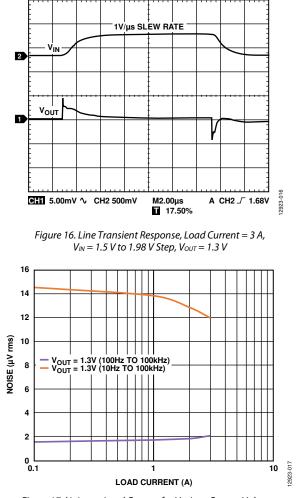
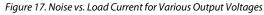


Figure 15. Load Transient Response, $C_{OUT} = 47 \,\mu$ F, $V_{IN} = 1.8 \,V$, $V_{OUT} = 1.3 \,V$

Data Sheet





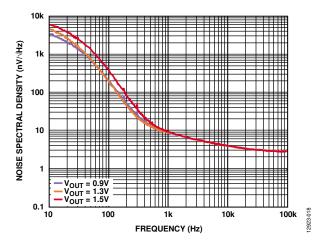


Figure 18. Noise Spectral Density vs. Frequency for Various Output Voltages, $I_{LOAD} = 100 \text{ mA}$

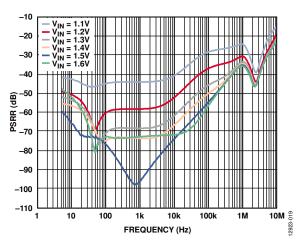


Figure 19. Power Supply Rejection Ratio (PSRR) vs. Frequency for Various Loads, $V_{OUT} = 0.9 V$, Load Current = 3 A

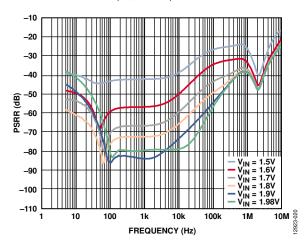


Figure 20. Power Supply Rejection Ratio (PSRR) vs. Frequency for Various Loads, Vour = 1.3 V, Load Current = 3 A

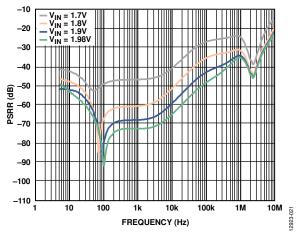
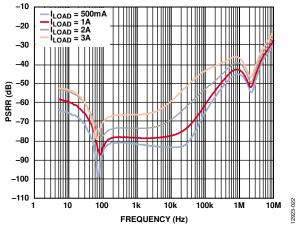
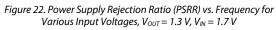


Figure 21. Power Supply Rejection Ratio (PSRR) vs. Frequency for Various Loads, V_{OUT} = 1.5 V, Load Current = 3 A

ADP1763





THEORY OF OPERATION

The ADP1763 is an LDO, low noise linear regulator that uses an advanced proprietary architecture to achieve high efficiency regulation. It also provides high PSRR and excellent line and load transient response using a small 10 μ F ceramic output capacitor. The device operates from a 1.10 V to 1.98 V input rail to provide up to 3 A of output current. Supply current in shutdown mode is typically 2 μ A.

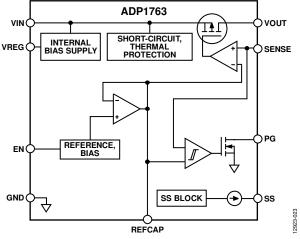


Figure 23. Functional Block Diagram, Fixed Output

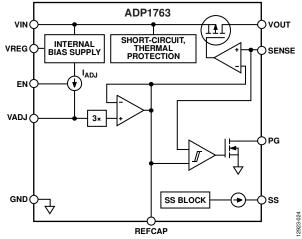


Figure 24. Functional Block Diagram, Adjustable Output

Internally, the ADP1763 consists of a reference, an error amplifier, and a pass device. The output current is delivered via the pass device, which is controlled by the error amplifier, forming a negative feedback system that ideally drives the feedback voltage to equal the reference voltage. If the feedback voltage is lower than the reference voltage, the negative feedback drives more current, increasing the output voltage. If the feedback voltage is higher than the reference voltage, the negative feedback drives less current, decreasing the output voltage.

The ADP1763 is available in output voltages ranging from 0.9 V to 1.5 V for a fixed output. Contact a local Analog Devices, Inc., sales representative for other fixed voltage options. The adjustable output option can be set from 0.5 V to 1.5 V.

The ADP1763 uses the EN pin to enable and disable the VOUT pin under normal operating conditions. When EN is high, VOUT turns on. When EN is low, VOUT turns off. For automatic startup, tie EN to VIN.

SOFT START FUNCTION

For applications that require a controlled startup, the ADP1763 provides a programmable soft start function. The programmable soft start is useful for reducing inrush current upon startup and for providing voltage sequencing. To implement soft start, connect a small ceramic capacitor from SS to GND. At startup, a 10 μ A current source charges this capacitor. The voltage at SS limits the ADP1763 start-up output voltage, providing a smooth ramp-up to the nominal output voltage. To calculate the start-up time for the fixed output and adjustable output, use the following equations:

$$t_{START-UP_FIXED} = t_{DELAY} + V_{REF} \times (C_{SS}/I_{SS})$$
(1)

$$t_{START-UP_ADJ} = t_{DELAY} + V_{ADJ} \times (C_{SS}/I_{SS})$$
⁽²⁾

where:

 t_{DELAY} is a fixed delay of 100 µs.

 V_{REF} is a 0.5 V internal reference for the fixed output model option. C_{SS} is the soft start capacitance from SS to GND.

 I_{ss} is the current sourced from SS (10 μ A).

 V_{ADJ} is the voltage at the VADJ pin equal to $R_{ADJ} \times I_{ADJ}$.

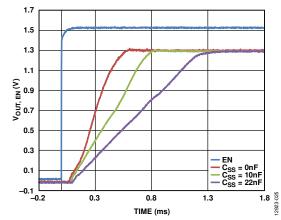


Figure 25. Fixed V_{OUT} Ramp-Up with External Soft Start Capacitor ($V_{OUT,EN}$) vs. Time

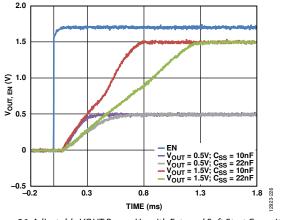


Figure 26. Adjustable VOUT Ramp-Up with External Soft Start Capacitor (Vout, EN) vs. Time

ADJUSTABLE OUTPUT VOLTAGE

The output voltage of the ADP1763 can be set over a 0.5 V to 1.5 V range. Connect a resistor (R_{ADI}) from the VADJ pin to ground to set the output voltage. To calculate the output voltage, use the following equation:

$$V_{OUT} = A_D \times (R_{ADJ} \times I_{ADJ}) \tag{3}$$

where:

 A_D is the gain factor with a typical value of 3.0 between the VADJ pin and the VOUT pin.

 I_{ADJ} is the 50.0 µA constant current out of the VADJ pin.

ENABLE FEATURE

The ADP1763 uses the EN pin to enable and disable the VOUT pins under normal operating conditions. As shown in Figure 27, when a rising voltage on EN crosses the active threshold, VOUT turns on. When a falling voltage on EN crosses the inactive threshold, VOUT turns off.

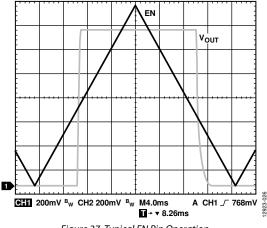


Figure 27. Typical EN Pin Operation

As shown in Figure 28, the EN pin has hysteresis built in. This hysteresis prevents on/off oscillations that can occur due to noise on the EN pin as it passes through the threshold points.

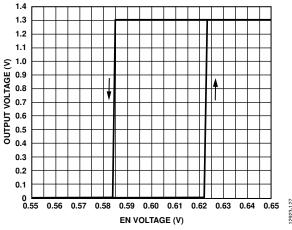


Figure 28. Output Voltage vs. Typical EN Pin Voltage, VOUT = 1.3 V

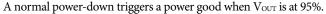
POWER-GOOD (PG) FEATURE

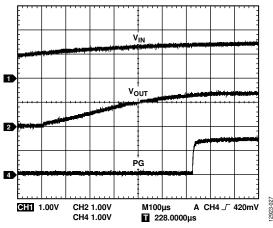
The ADP1763 provides a power-good pin (PG) to indicate the status of the output. This open-drain output requires an external pull-up resistor that can be connected to V_{IN} or V_{OUT} . If the device is in shutdown mode, current-limit mode, or thermal shutdown, or if it falls below 90% of the nominal output voltage, PG immediately transitions low. During soft start, the rising threshold of the power-good signal is 95% of the nominal output voltage.

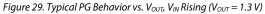
The open-drain output is held low when the ADP1763 has sufficient input voltage to turn on the internal PG transistor. An optional soft start delay can be detected. The PG transistor is terminated via a pull-up resistor to $V_{\rm OUT}$ or $V_{\rm IN}$.

Power-good accuracy is 92.5% of the nominal regulator output voltage when this voltage is rising, with a 95% trip point when this voltage is falling.

Regulator input voltage brownouts or glitches trigger a power no good if V_{OUT} falls below 92.5%.







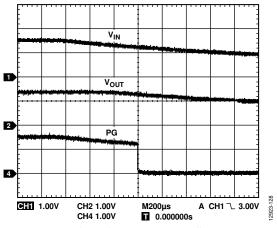


Figure 30. Typical PG Behavior vs. V_{OUT} , V_{IN} Falling ($V_{OUT} = 1.3 V$)

APPLICATIONS INFORMATION CAPACITOR SELECTION

Output Capacitor

The ADP1763 is designed for operation with small, space-saving ceramic capacitors, but it can function with most commonly used capacitors as long as care is taken with the effective series resistance (ESR) value. The ESR of the output capacitor affects the stability of the LDO control loop. A minimum of 10 μ F capacitance with an ESR of 500 m Ω or less is recommended to ensure the stability of the ADP1763. Transient response to changes in load current is also affected by output capacitance. Using a larger value of output capacitance improves the transient response of the ADP1763 to large changes in load current. Figure 31 and Figure 32 show the transient responses for output capacitance values of 10 μ F and 47 μ F, respectively.

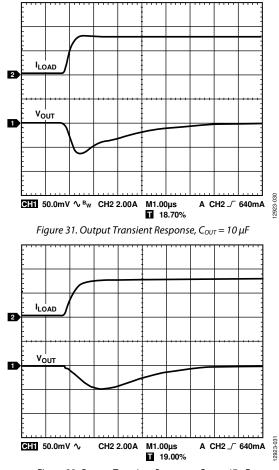


Figure 32. Output Transient Response, $C_{OUT} = 47 \, \mu F$

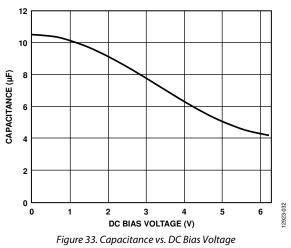
Input Bypass Capacitor

Connecting a 10 μ F capacitor from the VIN pin to the GND pin to ground reduces the circuit sensitivity to the PCB layout, especially when long input traces or a high source impedance is encountered. If output capacitance greater than 10 μ F is required, it is recommended that the input capacitor be increased to match it.

Input and Output Capacitor Properties

Use any good quality ceramic capacitors with the ADP1763, as long as they meet the minimum capacitance and maximum ESR requirements. Ceramic capacitors are manufactured with a variety of dielectrics, each with different behavior over temperature and applied voltage. Capacitors must have a dielectric adequate to ensure the minimum capacitance over the necessary temperature range and dc bias conditions. X5R or X7R dielectrics with a voltage rating of 6.3 V or 10 V are recommended. Y5V and Z5U dielectrics are not recommended, due to their poor temperature and dc bias characteristics.

Figure 33 shows the capacitance vs. bias voltage characteristics of an 0805 case, 10 μ F, 10 V, X5R capacitor. The voltage stability of a capacitor is strongly influenced by the capacitor size and voltage rating. In general, a capacitor in a larger package or with a higher voltage rating exhibits better stability. The temperature variation of the X5R dielectric is about ±15% over the -40°C to +85°C temperature range and is not a function of package size or voltage rating.



Use Equation 4 to determine the worst case capacitance, accounting for capacitor variation over temperature, component tolerance, and voltage.

$$C_{EFF} = C_{OUT} \times (1 - tempco) \times (1 - TOL)$$
(4)

where:

 C_{EFF} is the effective capacitance at the operating voltage. C_{OUT} is the output capacitor.

Tempco is the worst case capacitor temperature coefficient. *TOL* is the worst case component tolerance.

In this example, the worst case temperature coefficient (tempco) over -40° C to $+85^{\circ}$ C is assumed to be 15% for an X5R dielectric. The tolerance of the capacitor (TOL) is assumed to be 10%, and C_{OUT} = 10 µF at 1.0 V, as shown in Figure 33.

Substituting these values in Equation 4 yields

$$C_{EFF} = 10 \ \mu\text{F} \times (1 - 0.15) \times (1 - 0.1) = 7.65 \ \mu\text{F}$$

Therefore, the capacitor chosen in this example meets the minimum capacitance requirement of the LDO over temperature and tolerance at the chosen output voltage.

To guarantee the performance of the ADP1763, it is imperative that the effects of dc bias, temperature, and tolerances on the behavior of the capacitors be evaluated for each application.

UNDERVOLTAGE LOCKOUT

The ADP1763 has an internal undervoltage lockout circuit that disables all inputs and the output when the input voltage is less than approximately 1.06 V. The UVLO ensures that the ADP1763 inputs and the output behave in a predictable manner during power-up.

CURRENT-LIMIT AND THERMAL OVERLOAD PROTECTION

The ADP1763 is protected against damage due to excessive power dissipation by current-limit and thermal overload protection circuits. The ADP1763 is designed to reach the current limit when the output load reaches 4 A (typical). When the output load exceeds 4 A, the output voltage is reduced to maintain a constant current limit.

Thermal overload protection is included, which limits the junction temperature to a maximum of 150°C (typical). Under extreme conditions (that is, high ambient temperature and power dissipation) when the junction temperature begins to rise above 150°C, the output is turned off, reducing the output current to zero. When the junction temperature drops below 135°C (typical), the output is turned on again, and the output current is restored to its nominal value.

Consider the case where a hard short from VOUT to ground occurs. At first, the ADP1763 reaches the current limit so that only 4 A is conducted into the short circuit. If self heating of the junction becomes great enough to cause its temperature to rise above 150°C, thermal shutdown activates, turning off the output and reducing the output current to zero. As the junction temperature cools and drops below 135°C, the output turns on and conducts 4 A into the short circuit, again causing the junction temperature to rise above 150°C. This thermal oscillation between 135°C and 150°C causes a current oscillation between 4 A and 0 A that continues as long as the short circuit remains at the output.

Current-limit and thermal overload protections are intended to protect the device against accidental overload conditions. For reliable operation, limit device power dissipation externally so that junction temperatures do not exceed 125°C.

PARALLELING ADP1763 FOR HIGH CURRENT APPLICATIONS

In applications where high output current is required while maintaining low noise and high PSRR performance, connect two ADP1763 devices in parallel to handle loads up to 5 A.

When paralleling the ADP1763, the two outputs must be of the same voltage setting to maintain stable current sharing between the two LDO regulators. To improve current sharing accuracy, add identical ballast resistors ($R_{BALLAST}$) at the output of each regulator, as shown in Figure 34. Note that large ballast resistors improve current sharing accuracy but degrade the load regulation performance and increase the losses along the power line; therefore, it is recommended to keep the ballast resistors at a minimum. In addition, tie the VADJ, SS, and REFCAP pins of the LDO regulators together to minimize error between the two outputs.

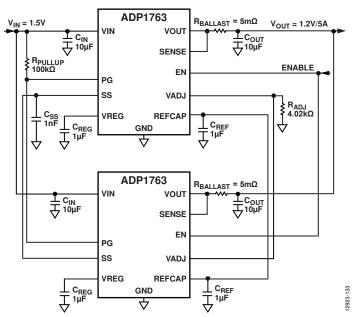


Figure 34. Two ADP1763 Devices Connected in Parallel to Achieve Higher Current Output

Use Equation 5 to calculate the output of the two paralleled ADP1763 LDOs.

$$V_{OUT} = 2 \times A_D \times (R_{ADJ} \times I_{ADJ})$$
⁽⁵⁾

where:

 A_D is the gain factor with a typical value of 3.0 between the VADJ pin and the VOUT pin.

 $\mathit{I}_{\mathit{ADJ}}$ is the 50.0 μA constant current out of the VADJ pin.

THERMAL CONSIDERATIONS

To guarantee reliable operation, the junction temperature of the ADP1763 must not exceed 125°C. To ensure that the junction temperature stays below this maximum value, the user needs to be aware of the parameters that contribute to junction temperature changes. These parameters include ambient temperature, power dissipation in the power device, and thermal resistance between the junction and ambient air (θ_{JA}). The θ_{JA} value is dependent on the package assembly compounds used and the amount of copper to which the GND pin and the exposed pad (EPAD) of the package are soldered on the PCB. Table 7 shows typical θ_{JA} values for the 16-lead LFCSP for various PCB copper sizes. Table 8 shows typical Ψ_{JB} values for the 16-lead LFCSP.

Table 7. Typical θ_{JA} Values

Copper Size (mm ²)	θ _{JA} (°C/W), LFCSP
25	138.1
100	102.9
500	76.9
1000	67.3
6400	56

Table 8. Typical Ψ_{JB} Values

Copper Size (mm ²)	Ψ _{JB} (°C/W) at 1 W
100	33.3
500	28.9
1000	28.5

To calculate the junction temperature of the ADP1763, use the following equation:

$$T_J = T_A + (P_D \times \theta_{JA}) \tag{6}$$

where:

 T_A is the ambient temperature.

 P_D is the power dissipation in the die, given by

$$P_D = ((V_{IN} - V_{OUT}) \times I_{LOAD}) + (V_{IN} \times I_{GND})$$
(7)

where:

 V_{IN} and V_{OUT} are the input and output voltages, respectively. I_{LOAD} is the load current.

*I*_{GND} is the ground current.

As shown in Equation 6, for a given ambient temperature, and computed power dissipation, a minimum copper size requirement exists for the PCB to ensure that the junction temperature does not rise above 125°C.

Figure 35 through Figure 40 show junction temperature calculations for different ambient temperatures, load currents, $V_{\rm IN}$ to $V_{\rm OUT}$ differentials, and areas of PCB copper.

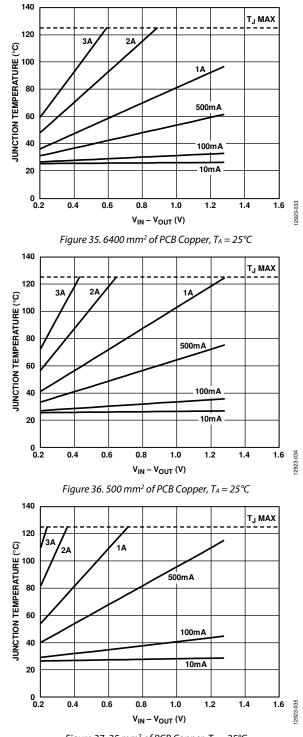


Figure 37. 25 mm² of PCB Copper, $T_A = 25^{\circ}C$

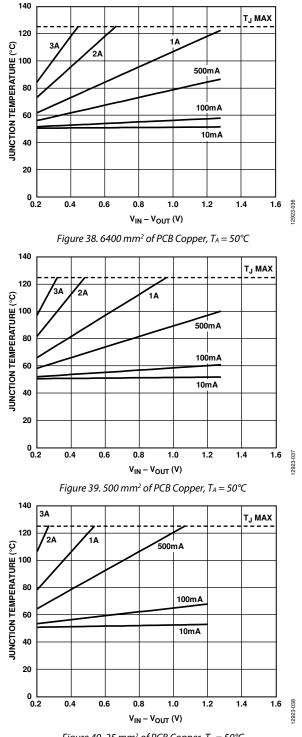


Figure 40. 25 mm² of PCB Copper, $T_A = 50^{\circ}C$

In cases where the board temperature is known, the thermal characterization parameter (Ψ_{JB}) can be used to estimate the junction temperature rise. The maximum junction temperature (T_J) is calculated from the board temperature (T_B) and power dissipation (P_D) using the following formula:

$$T_J = T_B + (P_D \times \Psi_{JB}) \tag{8}$$

Figure 41 through Figure 44 show junction temperature calculations for different board temperatures, load currents, $V_{\ensuremath{\text{IN}}}$ to $V_{\ensuremath{\text{OUT}}}$ differentials, and areas of PCB copper.

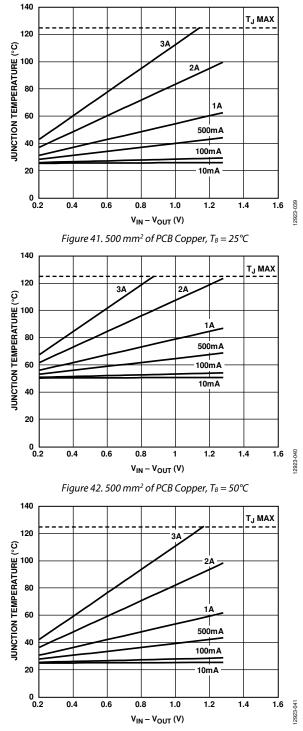


Figure 43. 1000 mm² of PCB Copper, $T_B = 25^{\circ}C$

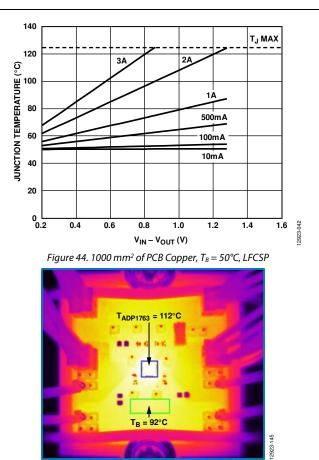


Figure 45. Thermal Image of the ADP1763 Evaluation Board at $I_{LOAD} = 3 A$, $V_{IN} = 1.5 V$, $V_{OUT} = 1.3 V$, $T_B = 92$ °C

Figure 45 shows a thermal image of the ADP1763 evaluation board operating at a 3 A current load. The total power dissipation on the ADP1763 is 600 mW, which makes the temperature on the surface of the device higher by 30°C than the temperature of the evaluation board.

PCB LAYOUT CONSIDERATIONS

Heat dissipation from the package can be improved by increasing the amount of copper attached to the pins of ADP1763. However, as shown in Table 8, a point of diminishing returns is eventually reached, beyond which an increase in the copper size does not yield significant heat dissipation benefits.

Use the following recommendations when designing PCBs:

- Place the input capacitor as close as possible to the VIN and GND pins.
- Place the output capacitor as close as possible to the VOUT and GND pins.
- Place the soft start capacitor (C_{ss}) as close as possible to the SS pin.
- Place the reference capacitor (C_{REF}) and regulator capacitor (C_{REG}) as close as possible to the REFCAP pin and VREG pin, respectively.
- Connect the load as close as possible to the VOUT and SENSE pins.

ADP1763

Use of 0603 or 0805 size capacitors and resistors achieves the smallest possible footprint solution on boards where area is limited.



Figure 46. Evaluation Board

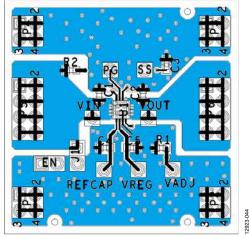


Figure 47. Typical Board Layout, Top Side

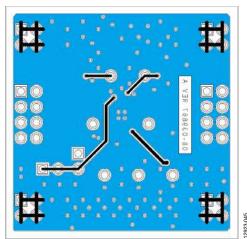


Figure 48. Typical Board Layout, Bottom Side

OUTLINE DIMENSIONS

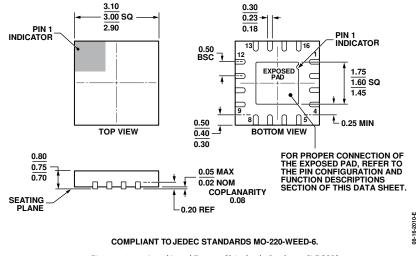


Figure 49. 16-Lead Lead Frame Chip Scale Package [LFCSP] 3 mm × 3 mm Body and 0.75 mm Package Height (CP-16-22) Dimensions shown in millimeters

ORDERING GUIDE

Model ¹	Temperature Range	Output Voltage (V) ²	Package Description	Package Option	Branding
ADP1763ACPZ-R7	-40°C to +125°C	Adjustable	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LSO
ADP1763ACPZ-0.9-R7	-40°C to +125°C	0.9	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS1
ADP1763ACPZ0.95-R7	-40°C to +125°C	0.95	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LUQ
ADP1763ACPZ-1.0-R7	-40°C to +125°C	1.0	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS2
ADP1763ACPZ-1.1-R7	-40°C to +125°C	1.1	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS3
ADP1763ACPZ-1.2-R7	-40°C to +125°C	1.2	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS4
ADP1763ACPZ1.25-R7	-40°C to +125°C	1.25	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS5
ADP1763ACPZ-1.3-R7	-40°C to +125°C	1.3	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS6
ADP1763ACPZ-1.5-R7	-40°C to +125°C	1.5	16-Lead Lead Frame Chip Scale Package [LFCSP]	CP-16-22	LS7
ADP1763-1.3-EVALZ		1.3	Evaluation Board		
ADP1763-ADJ-EVALZ		1.1	Evaluation Board		

 1 Z = RoHS Compliant Part.

² For additional options, contact a local Analog Devices sales or distribution representative. Additional voltage output options available include the following: 0.5 V, 0.6 V, 0.65 V, 0.7 V, 0.75 V, 0.8 V, 0.85 V, 1.05 V, 1.15 V, 1.35 V, 1.4 V, or 1.45 V.



www.analog.com